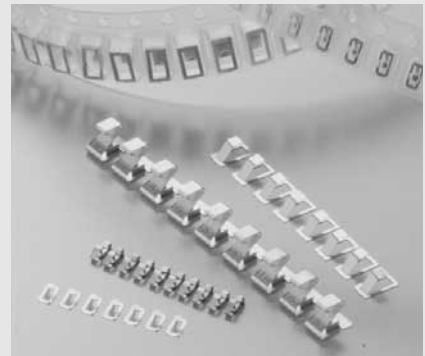
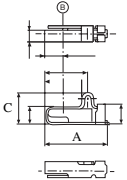
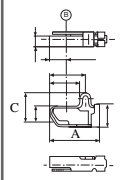
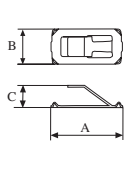
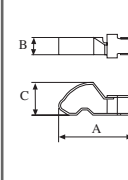
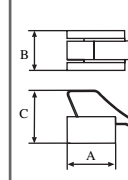


Features

- Contact components enable automatic mounting.
- Contact components enhance grounding effect around PCBs (printed circuit boards).
- Supplied with the enboss tape for autoinsertion assembly.
- Height 1.0mm- 7.0 mm are available.
- Improved spring form.



	OG-320816	OG-321022	OG-321610G	OG-340815P	OG-363040 OG-363050
A	3.2	3.2	3.2	3.4	3.6
B	0.8	1.0	1.6	0.8	3
C	1.6	2.2	1	1.5	4.0 (OG-363040) 5.0 (OG-363050)
Metal Thickness	0.12	0.12	0.08	0.08	0.1
Material	Phosphor Bronze	Phosphor Bronze	Stainless steel	BeCu	BeCu
Surface treatment	Partly Au plating on the underplating by Ni	Partly Au plating on the underplating by Ni	Partly Au plating on the underplating by Ni	Partly Au plating on the underplating by Ni	Ni plating Partly Sn plating on the underplating by Ni
Packing Quantity	8000	7000	3000	8000	1000
Dimensions					

More technical data upon request

	OG-450818	OG-502620R	OG-503040	OG-542925	OG-603060 OG-603070
A	4.5	5	5	5.4	6.0
B	0.8	2.6	3	2.9	3.0
C	1.8	2	4	2.5	6.0 (OG-603060) 7.0 (OG-603070)
Metal Thickness	0.12	0.08	0.1	0.12	0.12 (OG-603060) 0.08 (OG-603070)
Material	BeCu	Stainless steel	BeCu	Phosphor Bronze	Phosphor Bronze
Surface treatment	Partly Au plating on the underplating by Ni	Partly Au plating on the underplating by Ni	Sn plating	Partly Au plating on the underplating by Ni	Sn plating
Packing Quantity	8000	2000	1000	5000	850 (OG-603060) 750 (OG-603070)
Dimensions	